

54LS138,54LS139,DM54LS138,DM54LS139, DM74LS138,DM74LS139

54LS138 DM54LS138 DM74LS138 54LS139 DM54LS139 DM54LS139

Decoders/Demultiplexers



Literature Number: SNOS280A

54LS138/DM54LS138/DM74LS138, 54LS139/DM54LS139/DM74LS139 Decoders/Demultiplexers

General Description

These Schottky-clamped circuits are designed to be used in high-performance memory-decoding or data-routing applications, requiring very short propagation delay times. In high-performance memory systems these decoders can be used to minimize the effects of system decoding. When used with high-speed memories, the delay times of these decoders are usually less than the typical access time of the memory. This means that the effective system delay introduced by the decoder is negligible.

The LS138 decodes one-of-eight lines, based upon the conditions at the three binary select inputs and the three enable inputs. Two active-low and one active-high enable inputs reduce the need for external gates or inverters when expanding. A 24-line decoder can be implemented with no external inverters, and a 32-line decoder requires only one inverter. An enable input can be used as a data input for demultiplexing applications.

The LS139 comprises two separate two-line-to-four-line decoders in a single package. The active-low enable input can be used as a data line in demultiplexing applications.

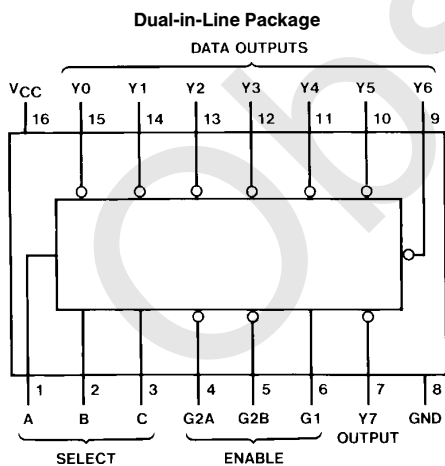
All of these decoders/demultiplexers feature fully buffered inputs, presenting only one normalized load to its driving circuit. All inputs are clamped with high-performance

Schottky diodes to suppress line-ringing and simplify system design.

Features

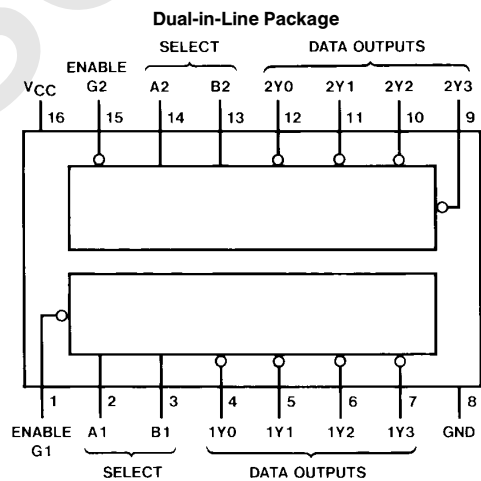
- Designed specifically for high speed:
 - Memory decoders
 - Data transmission systems
- LS138 3-to-8-line decoders incorporates 3 enable inputs to simplify cascading and/or data reception
- LS139 contains two fully independent 2-to-4-line decoders/demultiplexers
- Schottky clamped for high performance
- Typical propagation delay (3 levels of logic)
 - LS138 21 ns
 - LS139 21 ns
- Typical power dissipation
 - LS138 32 mW
 - LS139 34 mW
- Alternate Military/Aerospace devices (54LS138, 54LS139) are available. Contact a National Semiconductor Sales Office/Distributor for specifications.

Connection Diagrams



Order Number 54LS138DMQB, 54LS138FMBQ,
54LS138LMBQ, DM54LS138J, DM54LS138W,
DM74LS138M or DM74LS138N
See NS Package Number E20A, J16A,
M16A, N16E or W16A

TL/F/6391-1



Order Number 54LS139DMQB, 54LS139FMBQ,
54LS139LMBQ, DM54LS139J, DM54LS139W,
DM74LS139M or DM74LS139N
See NS Package Number E20A, J16A,
M16A, N16E or W16A

TL/F/6391-2

Absolute Maximum Ratings (Note)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	
DM54LS and 54LS	−55°C to +125°C
DM74LS	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	DM54LS138			DM74LS138			Units
		Min	Nom	Max	Min	Nom	Max	
V _{CC}	Supply Voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High Level Input Voltage	2			2			V
V _{IL}	Low Level Input Voltage			0.7			0.8	V
I _{OH}	High Level Output Current			−0.4			−0.4	mA
I _{OL}	Low Level Output Current			4			8	mA
T _A	Free Air Operating Temperature	−55		125	0		70	°C

'LS138 Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 1)	Max	Units
V _I	Input Clamp Voltage	V _{CC} = Min, I _I = −18 mA			−1.5	V
V _{OH}	High Level Output Voltage	V _{CC} = Min, I _{OH} = Max, V _{IL} = Max, V _{IH} = Min	DM54 2.5	3.4		V
			DM74 2.7	3.4		
V _{OL}	Low Level Output Voltage	V _{CC} = Min, I _{OL} = Max, V _{IL} = Max, V _{IH} = Min	DM54	0.25	0.4	V
			DM74	0.35	0.5	
		I _{OL} = 4 mA, V _{CC} = Min	DM74	0.25	0.4	
I _I	Input Current @ Max Input Voltage	V _{CC} = Max, V _I = 7V			0.1	mA
I _{IH}	High Level Input Current	V _{CC} = Max, V _I = 2.7V			20	μA
I _{IL}	Low Level Input Current	V _{CC} = Max, V _I = 0.4V			−0.36	mA
I _{OS}	Short Circuit Output Current	V _{CC} = Max (Note 2)	DM54 −20		−100	mA
			DM74 −20		−100	
I _{CC}	Supply Current	V _{CC} = Max (Note 3)		6.3	10	mA

Note 1: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 2: Not more than one output should be shorted at a time, and the duration should not exceed one second.

Note 3: I_{CC} is measured with all outputs enabled and open.

'LS138 Switching Characteristics

at $V_{CC} = 5V$ and $T_A = 25^\circ C$ (See Section 1 for Test Waveforms and Output Load)

Symbol	Parameter	From (Input) To (Output)	Levels of Delay	R _L = 2 kΩ				Units
				C _L = 15 pF		C _L = 50 pF		
				Min	Max	Min	Max	
t _{PLH}	Propagation Delay Time Low to High Level Output	Select to Output	2		18		27	ns
t _{PHL}	Propagation Delay Time High to Low Level Output	Select to Output	2		27		40	ns
t _{PLH}	Propagation Delay Time Low to High Level Output	Select to Output	3		18		27	ns
t _{PHL}	Propagation Delay Time High to Low Level Output	Select to Output	3		27		40	ns
t _{PLH}	Propagation Delay Time Low to High Level Output	Enable to Output	2		18		27	ns
t _{PHL}	Propagation Delay Time High to Low Level Output	Enable to Output	2		24		40	ns
t _{PLH}	Propagation Delay Time Low to High Level Output	Enable to Output	3		18		27	ns
t _{PHL}	Propagation Delay Time High to Low Level Output	Enable to Output	3		28		40	ns

Recommended Operating Conditions

Symbol	Parameter	DM54LS139			DM74LS139			Units
		Min	Nom	Max	Min	Nom	Max	
V_{CC}	Supply Voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High Level Input Voltage	2			2			V
V_{IL}	Low Level Input Voltage			0.7			0.8	V
I_{OH}	High Level Output Current			-0.4			-0.4	mA
I_{OL}	Low Level Output Current			4			8	mA
T_A	Free Air Operating Temperature	-55		125	0		70	$^\circ C$

'LS139 Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 1)	Max	Units
V_I	Input Clamp Voltage	$V_{CC} = \text{Min}, I_I = -18 \text{ mA}$			-1.5	V
V_{OH}	High Level Output Voltage	$V_{CC} = \text{Min}, I_{OH} = \text{Max}, V_{IL} = \text{Max}, V_{IH} = \text{Min}$	DM54 2.5	3.4		V
			DM74 2.7	3.4		
V_{OL}	Low Level Output Voltage	$V_{CC} = \text{Min}, I_{OL} = \text{Max}, V_{IL} = \text{Max}, V_{IH} = \text{Min}$	DM54	0.25	0.4	V
			DM74	0.35	0.5	
		$I_{OL} = 4 \text{ mA}, V_{CC} = \text{Min}$	DM74	0.25	0.4	
I_I	Input Current @ Max Input Voltage	$V_{CC} = \text{Max}, V_I = 7V$			0.1	mA
I_{IH}	High Level Input Current	$V_{CC} = \text{Max}, V_I = 2.7V$			20	μA
I_{IL}	Low Level Input Current	$V_{CC} = \text{Max}, V_I = 0.4V$			-0.36	mA
I_{OS}	Short Circuit Output Current	$V_{CC} = \text{Max}$ (Note 2)	DM54 -20		-100	mA
			DM74 -20		-100	
I_{CC}	Supply Current	$V_{CC} = \text{Max}$ (Note 3)		6.8	11	mA

Note 1: All typicals are at $V_{CC} = 5V, T_A = 25^\circ\text{C}$.

Note 2: Not more than one output should be shorted at a time, and the duration should not exceed one second.

Note 3: I_{CC} is measured with all outputs enabled and open.

'LS139 Switching Characteristics

at $V_{CC} = 5V$ and $T_A = 25^\circ\text{C}$ (See Section 1 for Test Waveforms and Output Load)

Symbol	Parameter	From (Input) To (Output)	$R_L = 2\text{ k}\Omega$				Units
			$C_L = 15\text{ pF}$		$C_L = 50\text{ pF}$		
			Min	Max	Min	Max	
t _{PLH}	Propagation Delay Time Low to High Level Output	Select to Output		18		27	ns
t _{PHL}	Propagation Delay Time High to Low Level Output	Select to Output		27		40	ns
t _{PLH}	Propagation Delay Time Low to High Level Output	Enable to Output		18		27	ns
t _{PHL}	Propagation Delay Time High to Low Level Output	Enable to Output		24		40	ns

Function Tables

LS138

Inputs					Outputs							
Enable		Select										
G1	G2*	C	B	A	Y0	Y1	Y2	Y3	Y4	Y5	Y6	Y7
X	H	X	X	X	H	H	H	H	H	H	H	H
L	X	X	X	X	H	H	H	H	H	H	H	H
H	L	L	L	L	L	H	H	H	H	H	H	H
H	L	L	L	L	H	L	H	H	H	H	H	H
H	L	L	L	H	H	H	L	H	H	H	H	H
H	L	L	H	H	H	H	L	H	H	H	H	H
H	L	L	H	L	H	H	H	H	L	H	H	H
H	L	L	H	L	H	H	H	H	H	L	H	H
H	L	L	H	H	H	H	H	H	H	H	L	H
H	L	L	H	H	H	H	H	H	H	H	H	L

* $G2 = G2A + G2B$

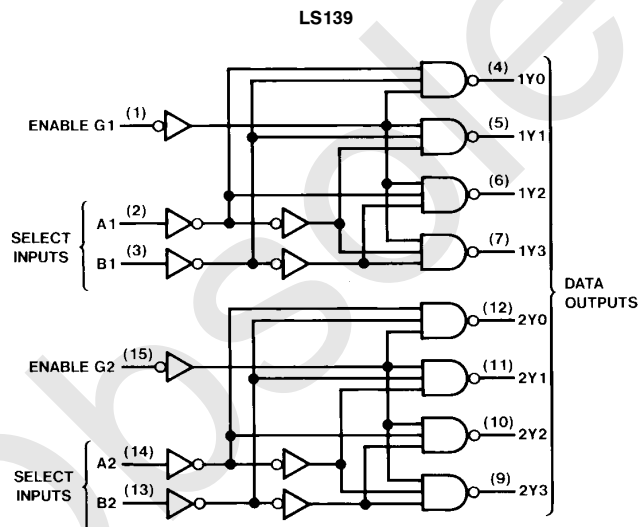
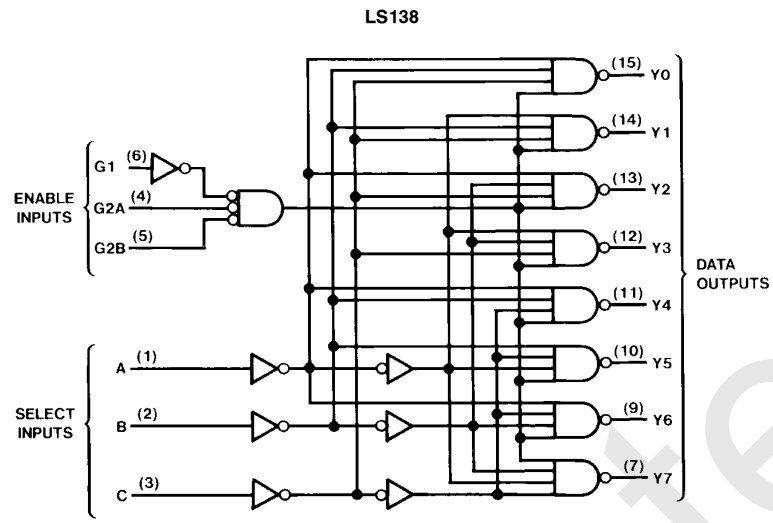
H = High Level, L = Low Level, X = Don't Care

LS139

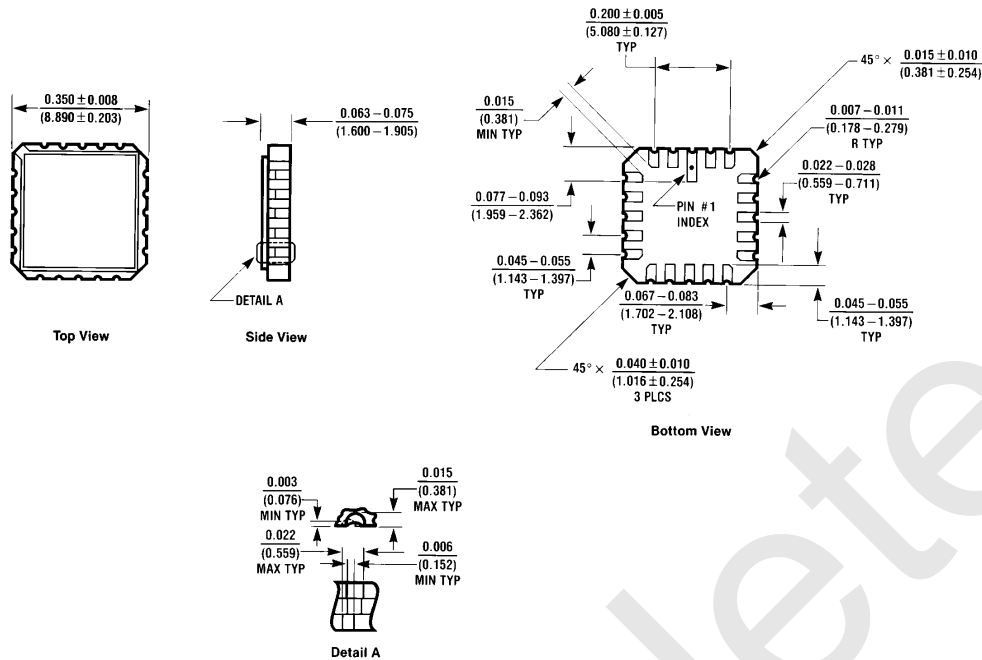
Inputs			Outputs			
Enable	Select					
G	B	A	Y0	Y1	Y2	Y3
H	X	X	H	H	H	H
L	L	L	L	H	H	H
L	L	H	H	L	H	H
L	H	L	H	H	L	H
L	H	H	H	H	H	L

H = High Level, L = Low Level, X = Don't Care

Logic Diagrams

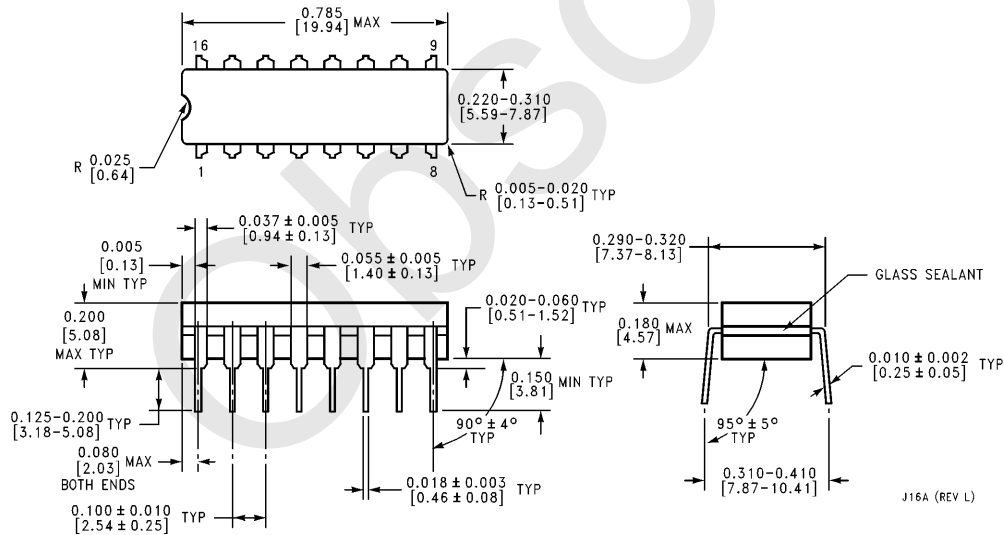


Physical Dimensions inches (millimeters)



E20A (REV D)

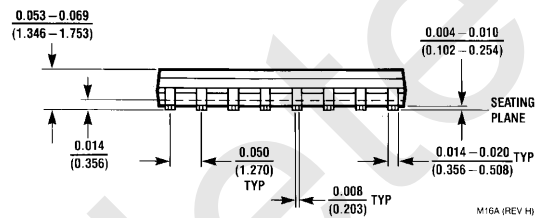
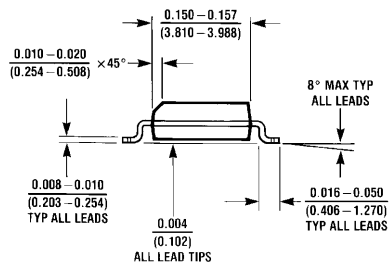
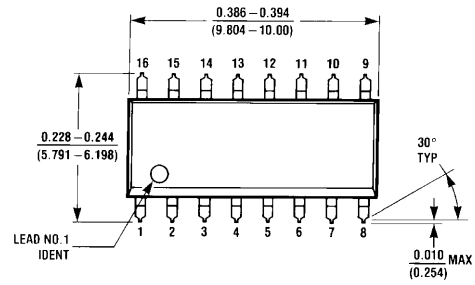
Ceramic Leadless Chip Carrier Package (E)
Order Number 54LS138LMQB or 54LS139LMQB
NS Package Number E20A



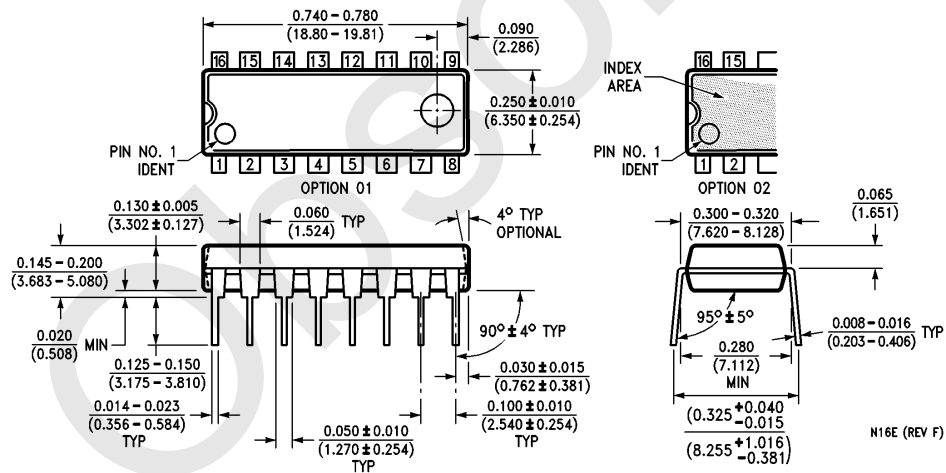
J16A (REV L)

16-Lead Ceramic Dual-In-Line Package (J)
Order Number 54LS138DMQB, 54LS139DMQB, DM54LS138J or DM54LS139J
NS Package Number J16A

Physical Dimensions inches (millimeters) (Continued)

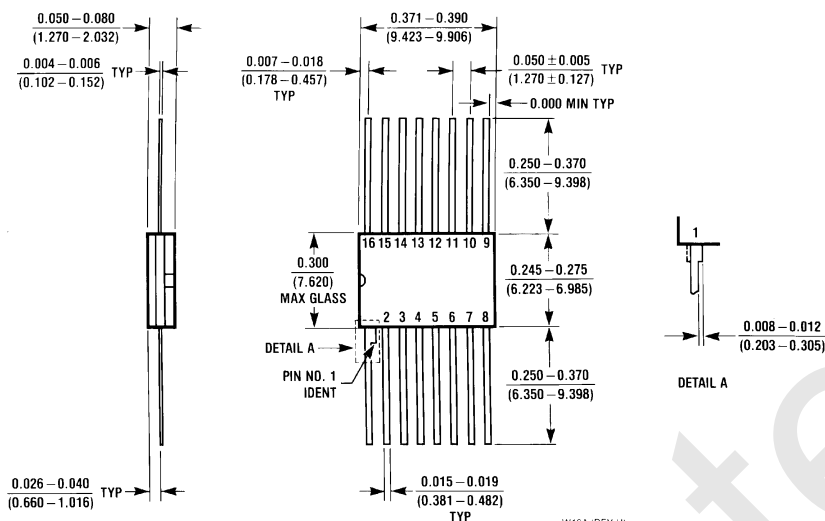


16-Lead Small Outline Molded Package (M)
Order Number DM74LS138M or DM74LS139M
NS Package Number M16A



16-Lead Molded Dual-In-Line Package (N)
Order Number DM74LS138N or DM74LS139N
NS Package Number N16E

Physical Dimensions inches (millimeters) (Continued)



16-Lead Ceramic Flat Package (W)
Order Number 54LS138FMQB, 54LS139FMQB, DM54LS138W or DM54LS139W
NS Package Number W16A

LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



National Semiconductor Corporation
 1111 West Bardin Road
 Arlington, TX 76017
 Tel: 1(800) 272-9959
 Fax: 1(800) 737-7018

National Semiconductor Europe
 Fax: (+49) 0-180-530 85 86
 Email: cnjwge@tevm2.nsc.com
 Deutsch Tel: (+49) 0-180-530 85 85
 English Tel: (+49) 0-180-532 78 32
 Français Tel: (+49) 0-180-532 93 58
 Italiano Tel: (+49) 0-180-534 16 80

National Semiconductor Hong Kong Ltd.
 13th Floor, Straight Block,
 Ocean Centre, 5 Canton Rd.
 Tsimshatsui, Kowloon
 Hong Kong
 Tel: (852) 2737-1600
 Fax: (852) 2736-9960

National Semiconductor Japan Ltd.
 Tel: 81-043-299-2309
 Fax: 81-043-299-2408

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products

Audio	www.ti.com/audio
Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
OMAP Mobile Processors	www.ti.com/omap
Wireless Connectivity	www.ti.com/wirelessconnectivity

Applications

Communications and Telecom	www.ti.com/communications
Computers and Peripherals	www.ti.com/computers
Consumer Electronics	www.ti.com/consumer-apps
Energy and Lighting	www.ti.com/energy
Industrial	www.ti.com/industrial
Medical	www.ti.com/medical
Security	www.ti.com/security
Space, Avionics and Defense	www.ti.com/space-avionics-defense
Transportation and Automotive	www.ti.com/automotive
Video and Imaging	www.ti.com/video

TI E2E Community Home Page

e2e.ti.com

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2011, Texas Instruments Incorporated